

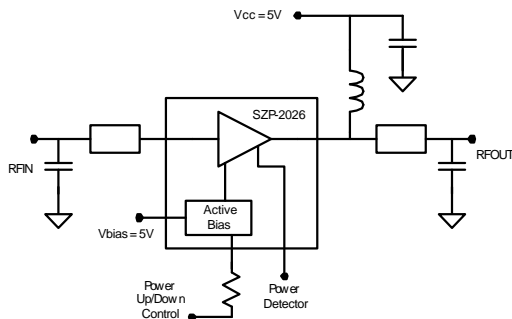


## Product Description

Sirenza Microdevices' SZP-2026Z is a high linearity single stage class AB Heterojunction Bipolar Transistor (HBT) amplifier housed in a proprietary surface-mountable plastic encapsulated package. This HBT amplifier is made with InGaP on GaAs device technology and fabricated with MOCVD for an ideal combination of low cost and high reliability.

This product is specifically designed as a flexible final or driver stage for 802.16 and 802.11 equipment in the 2.2-2.7GHz bands. It can run from a 3V to 6V supply. It is pre-matched to ~5 ohms on the input for broadband performance and ease of matching at the board level. It features an output power detector, on/off power control, ESD protection, excellent overall robustness and a proprietary hand reworkable and thermally enhanced SOF-26 package. This product features a RoHS Compliant and Green package with matte tin finish, designated by the 'Z' suffix.

### Functional Block Diagram



### Key Specifications

Symbol	Parameters: Test Conditions, 2.5-2.7GHz App circuit, $Z_0 = 50\Omega$ , $V_{CC} = 5.0V$ , $I_q = 445mA$ , $T_{BP} = 30^\circ C$	Unit	Min.	Typ.	Max.
$f_O$	Frequency of Operation	MHz	2200		2700
$P_{1dB}$	Output Power at 1dB Compression - 2.7GHz	dBm	31.5	33	
$S_{21}$	Small Signal Gain - 2.7GHz	dB	11.3	12.8	
Pout	Output power at 2.5% EVM 802.11g 54Mb/s - 2.5GHz	dBm		26.2	
IM3	Third Order Suppression (Pout=23dBm per tone) - 2.7GHz	dBc		-45	-42
NF	Noise Figure at 2.7GHz	dB		4.3	
IRL	Worst Case Input Return Loss 2.5-2.7GHz	dB	8	12	
ORL	Worst Case Output Return Loss 2.5-2.7GHz		8	12	
Vdet Range	Output Voltage Range for Pout=10dBm to 33dBm	V		0.85 to 1.4	
$I_{cq}$	Quiescent Current ( $V_{CC} = 5V$ )	mA	395	445	495
$I_{VPC}$	Power Up Control Current ( $V_{PC} = 5V$ )	mA		2.1	
$I_{leak}$	Vcc Leakage Current ( $V_{CC} = 5V$ , $V_{PC} = 0V$ )	$\mu A$			10
$R_{th, j-l}$	Thermal Resistance (junction - lead)	$^\circ C/W$		12	

The information provided herein is believed to be reliable at press time. Sirenza Microdevices assumes no responsibility for inaccuracies or omissions. Sirenza Microdevices assumes no responsibility for the use of this information, and all such information shall be entirely at the user's own risk. Prices and specifications are subject to change without notice. No patent rights or licenses to any of the circuits described herein are implied or granted to any third party. Sirenza Microdevices does not authorize or warrant any Sirenza Microdevices product for use in life-support devices and/or systems.

Copyright 2002 Sirenza Microdevices, Inc. All worldwide rights reserved.  
303 South Technology Court Broomfield, CO 80021

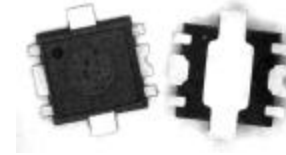
Phone: (800) SMI-MMIC

<http://www.sirenza.com>  
EDS-104611 Rev C

Preliminary

## SZP-2026Z

### 2.2-2.7GHz 2W InGaP Amplifier



Proprietary SOF-26 Package

### Product Features

- $P_{1dB} = 33.5dBm @ 5V, 2.4GHz$
- 802.11g 54Mb/s Class AB Performance  
 $P_{out} = 26dBm @ 2.5\%EVM, V_{CC} 5V$   
 $P_{out} = 27dBm @ 2.5\% EVM, V_{CC} 6V$
- On-chip Output Power Detector
- Input Prematched to ~5 ohms
- Proprietary Low Thermal Resistance Package  
Hand Solderable and Easy Rework
- Power up/down control < 1 $\mu s$

### Applications

- 802.16 WiMAX Driver or Output Stage
- 2.4GHz 802.11 WLAN and ISM Applications



**Preliminary**  
**SZP-2026Z 2.2-2.7GHz 2W Power Amp**

**Typical Performance 2.4-2.5GHz App Circuit (Vcc=5V, Icq=445mA, \* 802.11g 54Mb/s 64QAM)**

Parameter	Units	2.4GHz	2.5GHz
Gain	dB	13.3	13.0
P1dB	dBm	33.5	33.3
Pout @ 2.5% EVM*	dBm	26	26
Current @ Pout 2.5% EVM*	mA	550	545
Input Return Loss	dB	16	12
Output Return Loss	dB	16	16

**Typical Performance 2.5-2.7GHz - Refer to page 1 table**

**Pin Out Description**

Pin #	Function	Description
1	VBIAS	This is the supply voltage for the active bias circuit.
2	RFIN	This is the RF input pin and has a DC voltage present. An external DC block is required.
3	VPC	Power up/down control pin. The voltage on this pin should never exceed the voltage on pin 3 by more than 0.5V unless the supply current from pin 3 is limited < 10mA.
4	VDET	This is the output port for the power detector. It samples the power at the input of the amplifier.
5	RFOUT/VCC	This is the RF output pin and DC connection to the collector.
6	NC	This pin is not connected internal to the package. Buss it to pin 5 as shown on the app circuit to achieve the specified performance.
GND	GND	These pins are DC connected to the backside paddle. They provide good thermal connection to the backside paddle for hand soldering and rework. Many thermal and electrical GND vias are recommended as shown in the landing pattern.

**Absolute Maximum Ratings**

Parameters	Value	Unit
VC1 Collector Bias Current (I <sub>VC1</sub> )	1500	mA
**Device Voltage (V <sub>CD</sub> )	7.0	V
Power Dissipation	6	W
Operating Lead Temperature (T <sub>L</sub> )	-40 to +85	°C
*Max RF output Power for 50 ohm continuous long term operation	30	dBm
Max RF Input Power for 50 ohm output load	28	dBm
Max RF Input Power for 10:1 VSWR output load	23	dBm
Storage Temperature Range	-40 to +150	°C
Operating Junction Temperature (T <sub>J</sub> )	+150	°C
ESD Human Body Model	1000	V

Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation the device voltage and current must not exceed the maximum operating values specified in the table on page one.

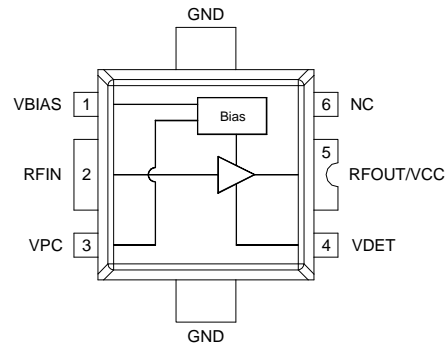
Bias conditions should also satisfy the following expression:  

$$I_D V_D < (T_J - T_L) / R_{TH} \cdot j-I$$

\* With specified application circuit.

\*\* No RF Drive

**Simplified Device Schematic**



**Caution: ESD Sensitive**

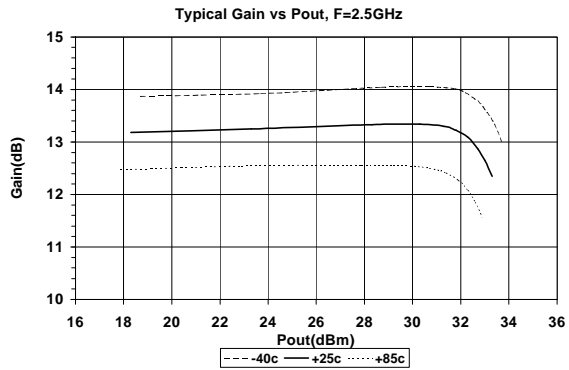
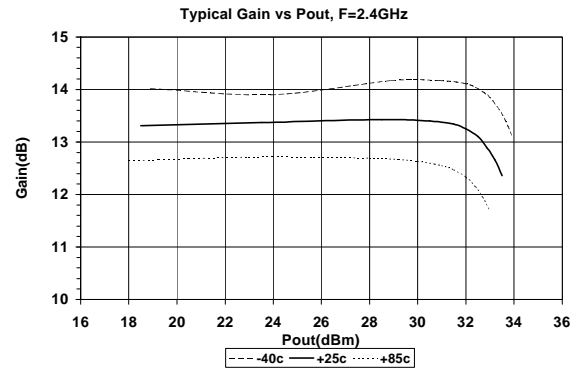
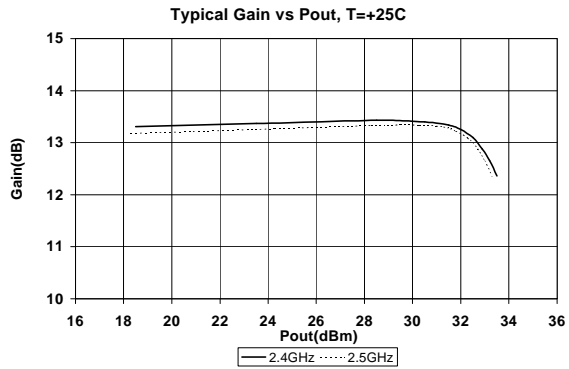
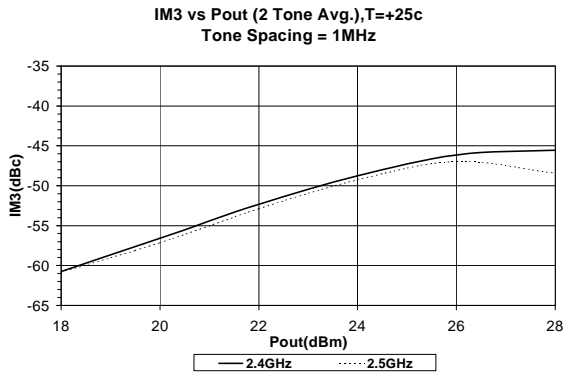
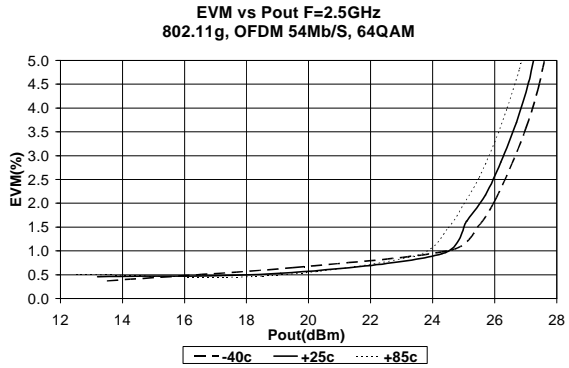
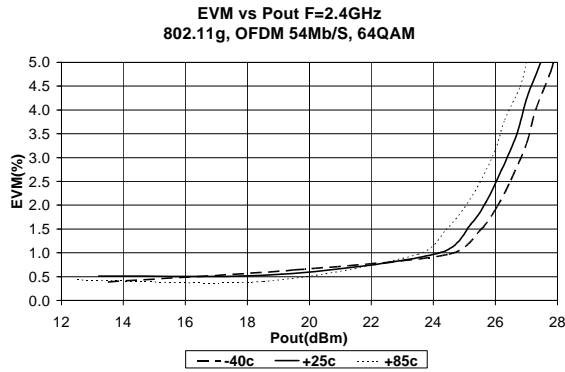
Appropriate precaution in handling, packaging and testing devices must be observed.



**Preliminary**  
**SZP-2026Z 2.2-2.7GHz 2W Power Amp**

**Measured 2.4-2.5 GHz Application Circuit Data ( $V_{CC} = V_{PC} = 5.0V$ ,  $I_Q = 445mA$ ,  $T=25C$ )**

Source EVM = 0.6%, not deembedded from data.

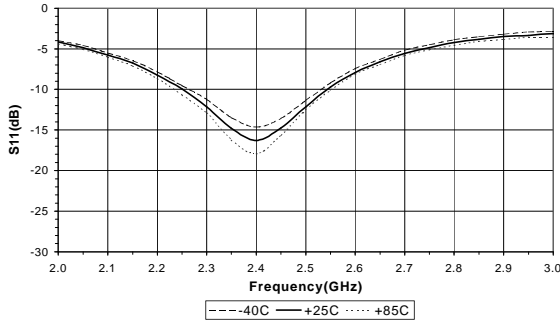




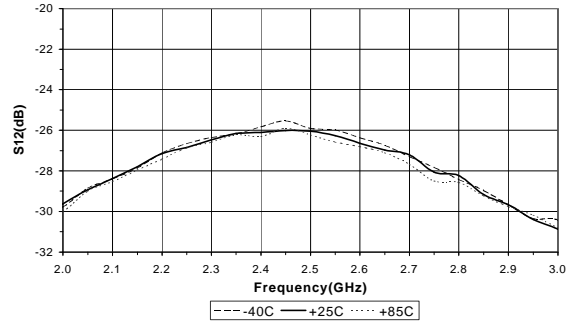
**Preliminary**  
**SZP-2026Z 2.2-2.7GHz 2W Power Amp**

Measured 2.4-2.5 GHz Application Circuit Data ( $V_{CC} = V_{PC} = 5.0V$ ,  $I_q = 445mA$ ,  $T=25C$ )

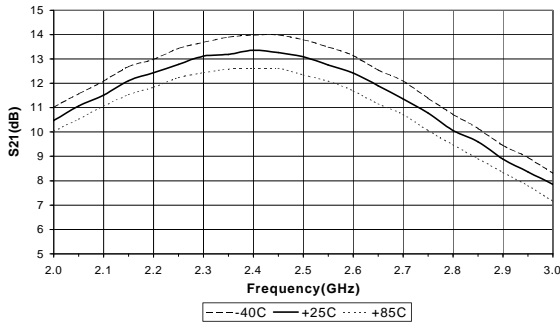
Narrowband S11 - Input Return Loss



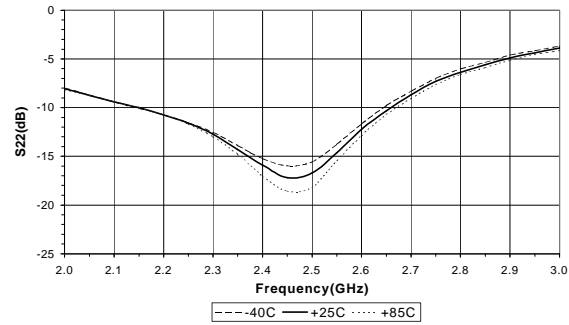
Narrowband S12 - Reverse Isolation



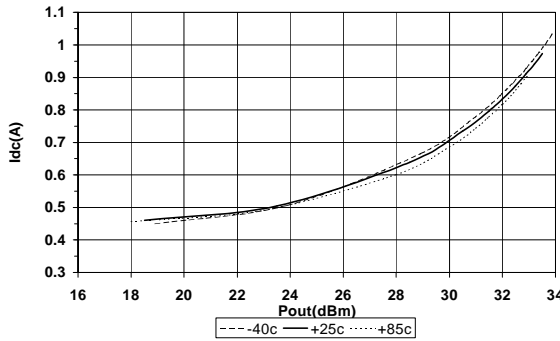
Narrowband S21 - Forward Gain



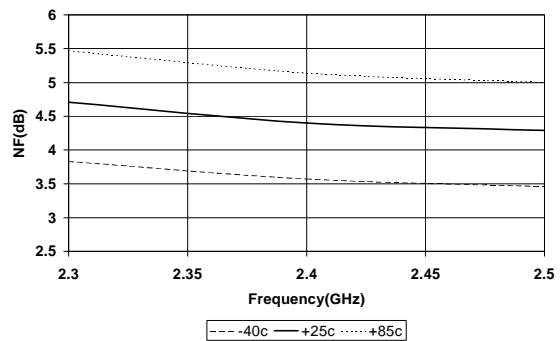
Narrowband S22 - Output Return Loss



DC Supply Current vs Pout, F=2.4GHz



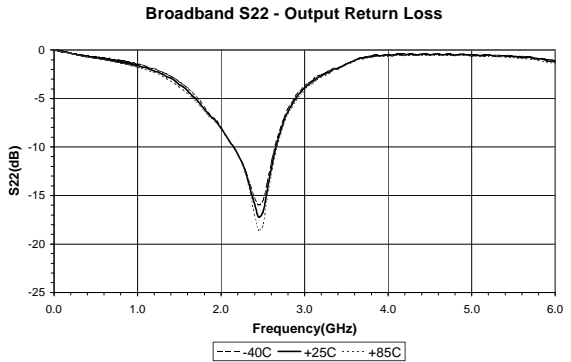
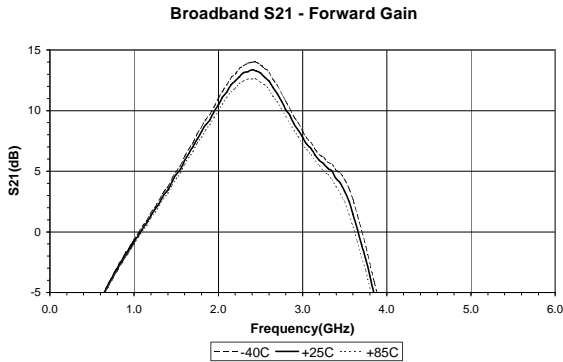
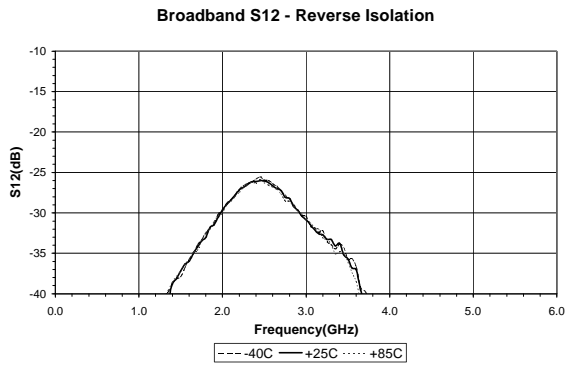
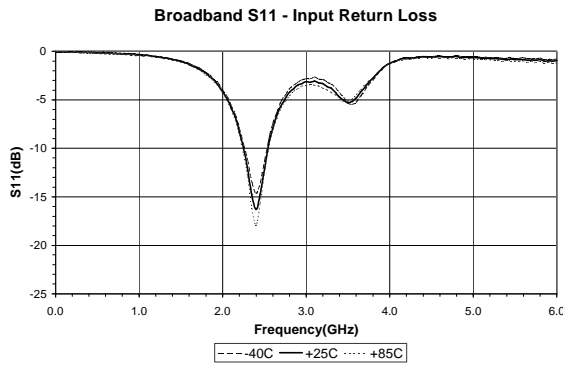
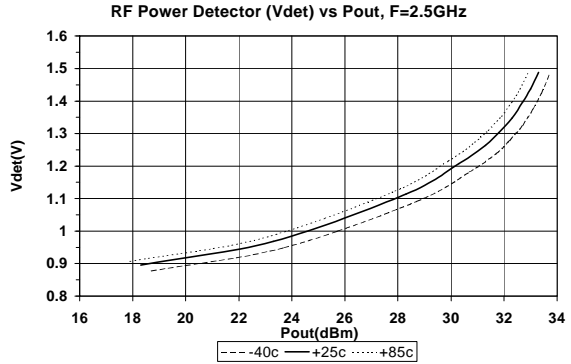
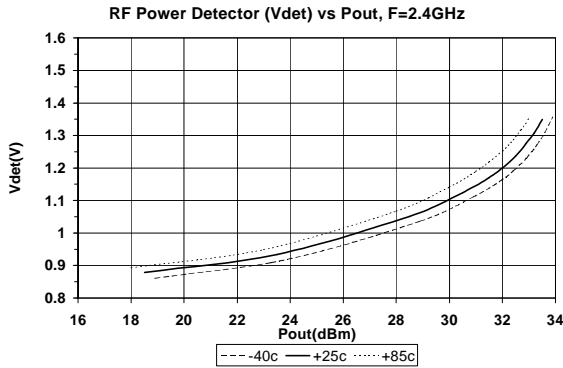
Noise Figure vs Frequency, O.T.





**Preliminary**  
SZP-2026Z 2.2-2.7GHz 2W Power Amp

Measured 2.4-2.5 GHz Application Circuit Data ( $V_{CC} = V_{PC} = 5.0V$ ,  $I_q = 445mA$ ,  $T=25C$ )

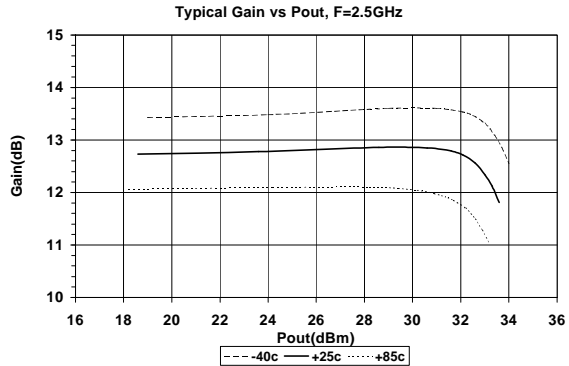
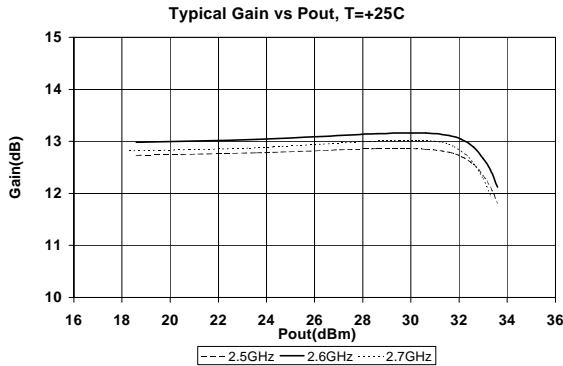
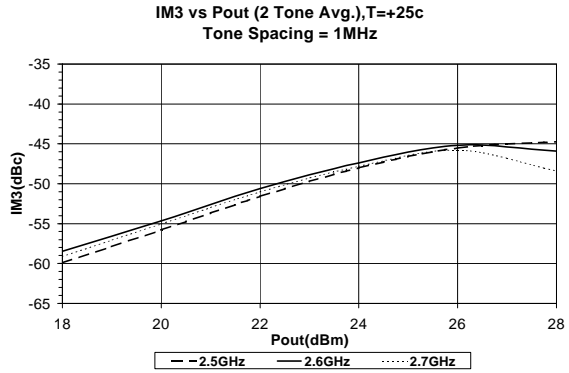
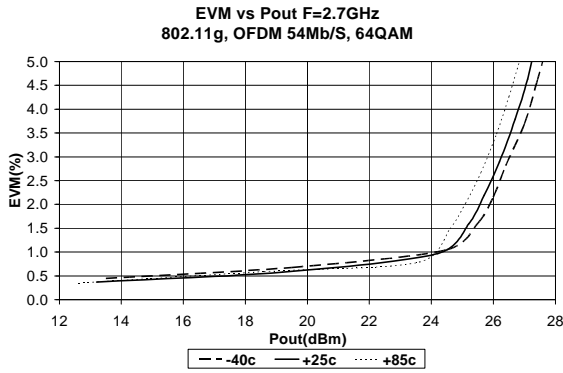
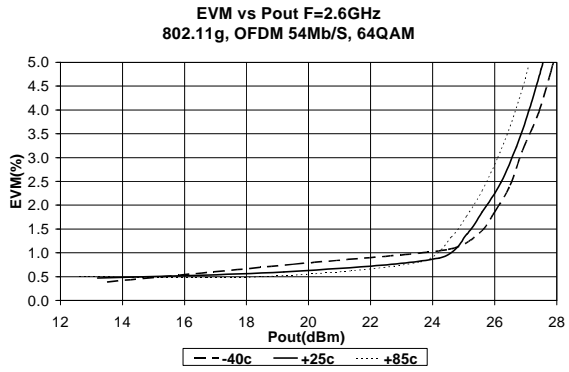
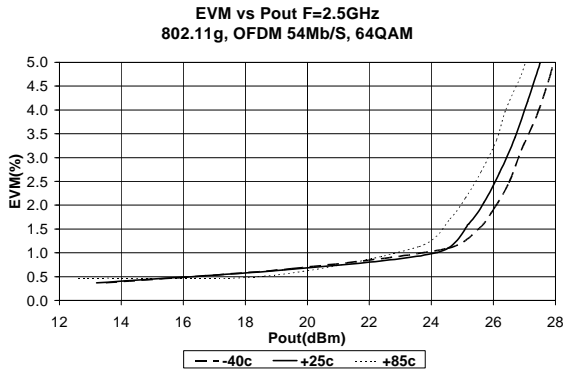




**Preliminary**  
**SZP-2026Z 2.2-2.7GHz 2W Power Amp**

**Measured 2.5-2.7 GHz Application Circuit Data ( $V_{cc} = V_{pc} = 5.0V$ ,  $I_q = 445mA$ ,  $T=25C$ )**

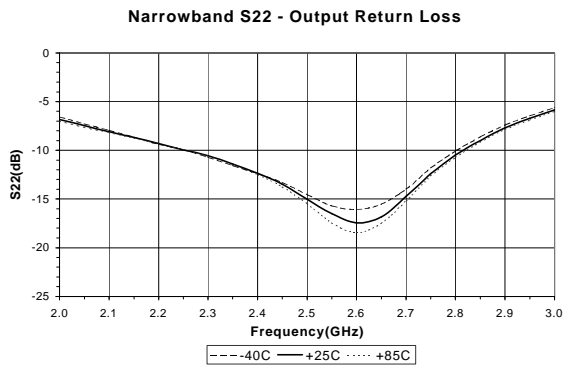
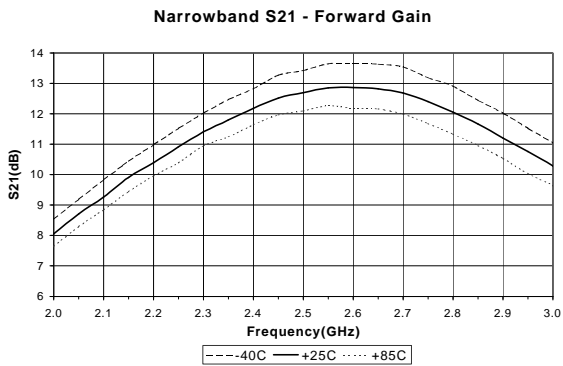
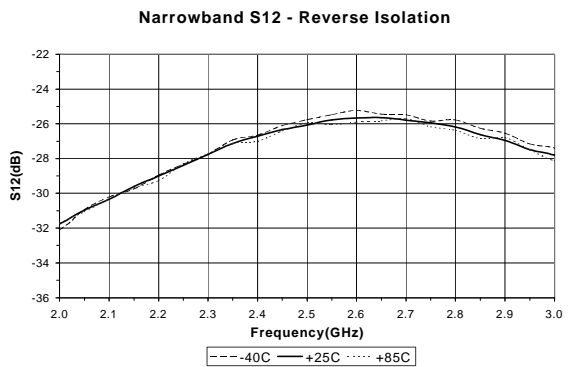
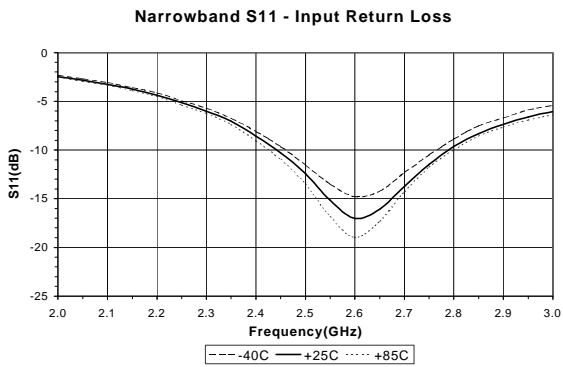
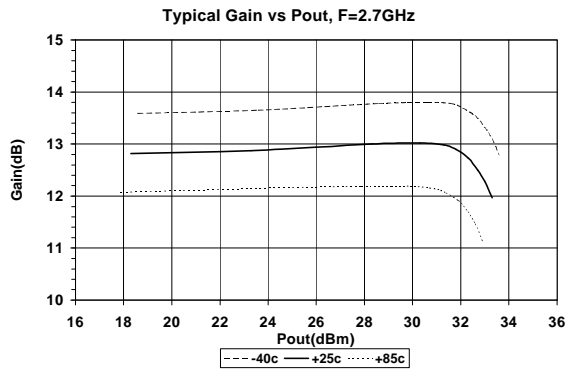
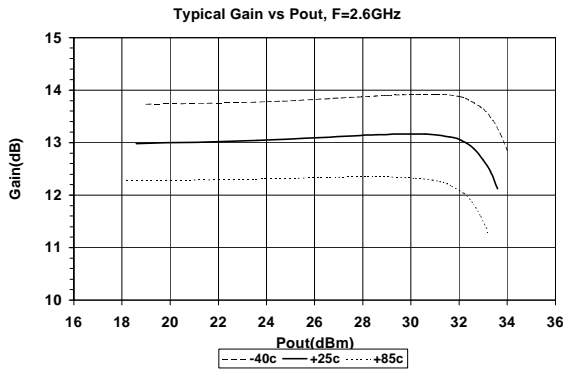
Source EVM = 0.6%, not deembedded from data.





**Preliminary**  
**SZP-2026Z 2.2-2.7GHz 2W Power Amp**

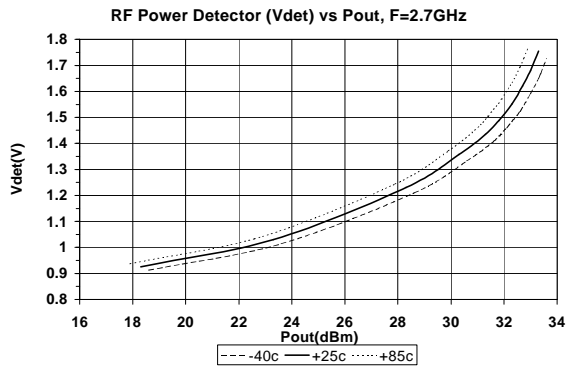
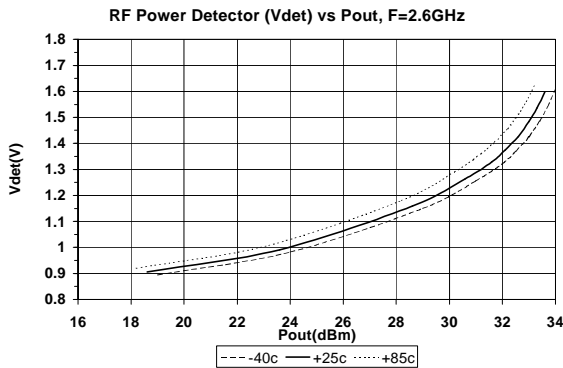
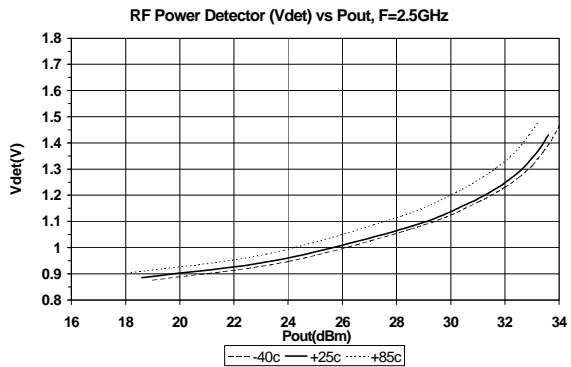
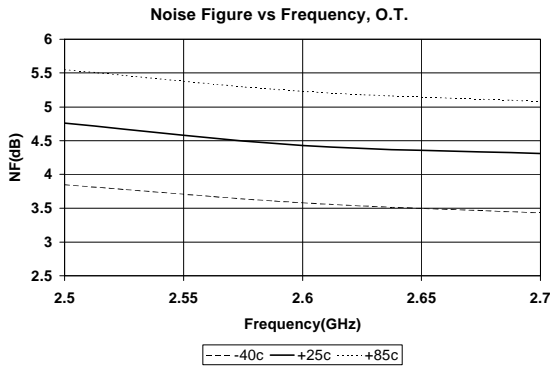
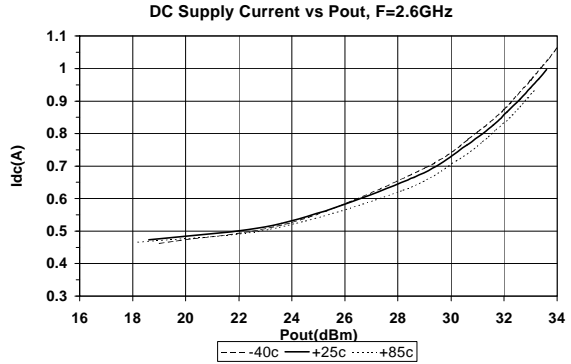
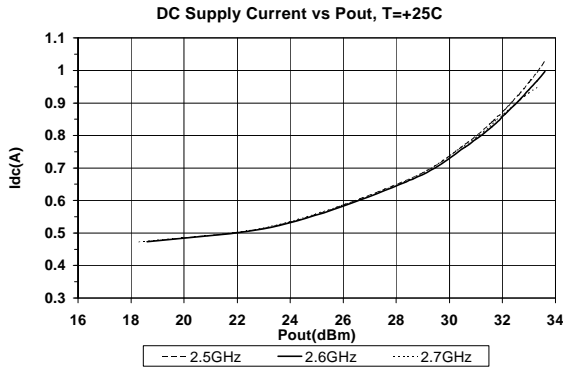
Measured 2.5-2.7 GHz Application Circuit Data ( $V_{CC} = V_{PC} = 5.0V$ ,  $I_q = 445mA$ ,  $T=25C$ )





**Preliminary**  
SZP-2026Z 2.2-2.7GHz 2W Power Amp

Measured 2.5-2.7 GHz Application Circuit Data ( $V_{CC} = V_{PC} = 5.0V$ ,  $I_q = 445mA$ ,  $T=25C$ )

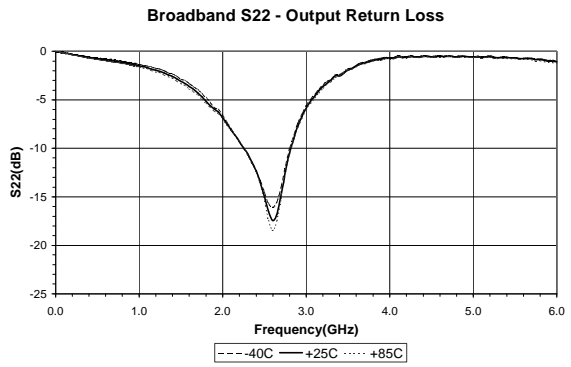
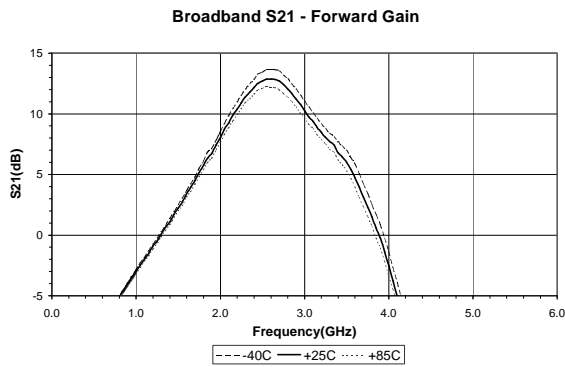
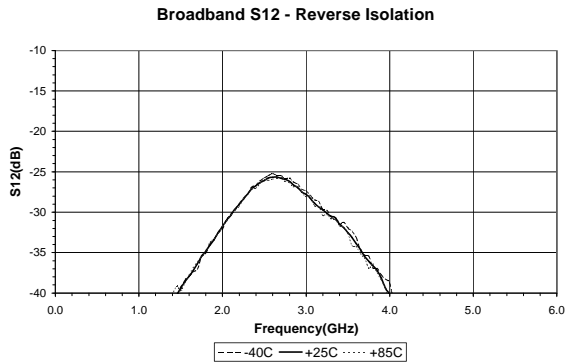
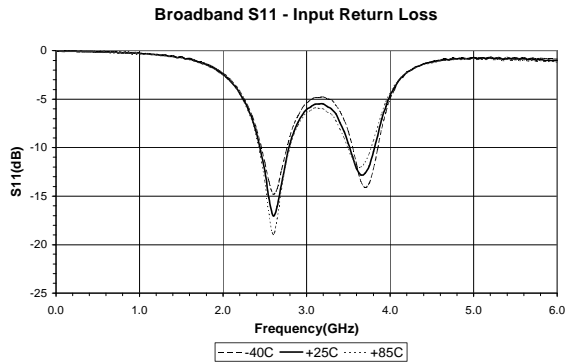






**Preliminary**  
**SZP-2026Z 2.2-2.7GHz 2W Power Amp**

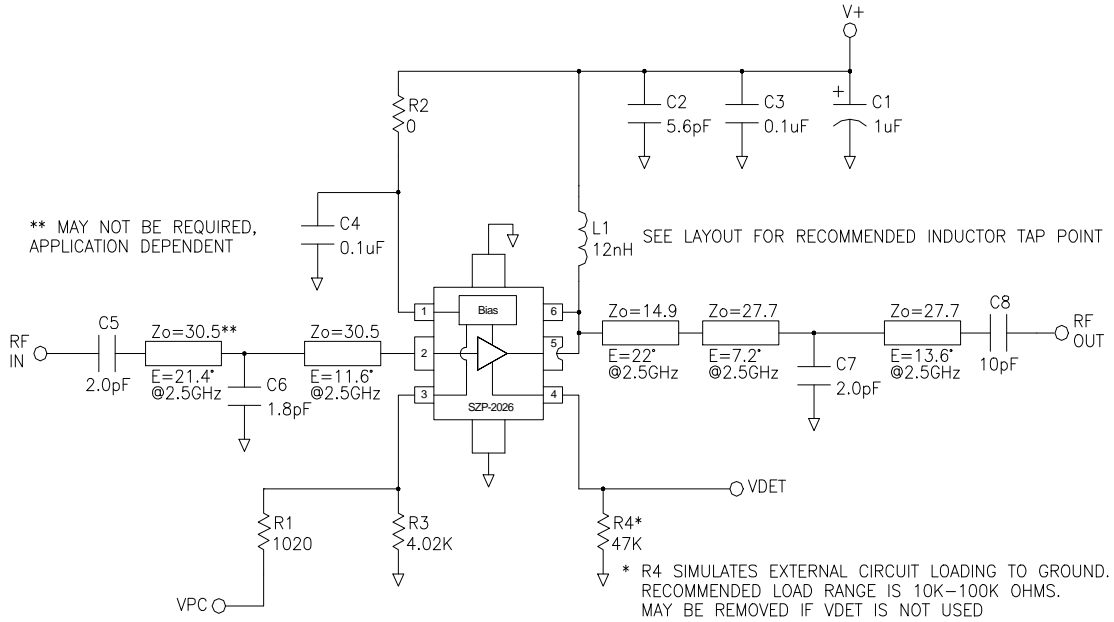
Measured 2.5-2.7 GHz Application Circuit Data ( $V_{CC} = V_{PC} = 5.0V$ ,  $I_q = 445mA$ ,  $T=25C$ )





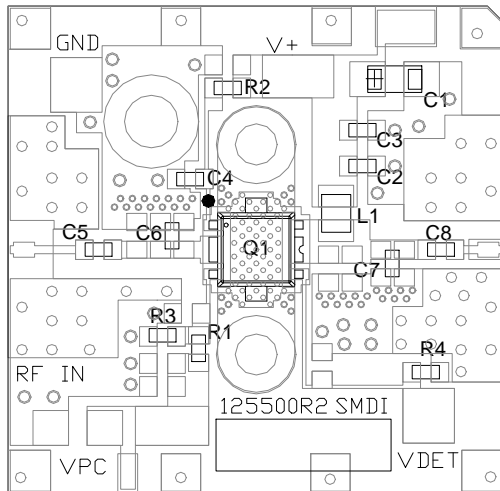
**Preliminary**  
**SZP-2026Z 2.2-2.7GHz 2W Power Amp**

**2.4-2.5 GHz Application Circuit For  $V_+ = V_{cc} = V_{pc} = 5.0V$**



**2.4-2.5GHz Evaluation Board Layout For  $V_+ = V_{cc} = V_{pc} = 5.0V$**

Board material GETEK, 10mil thick, Dk=3.9, 2 oz. copper

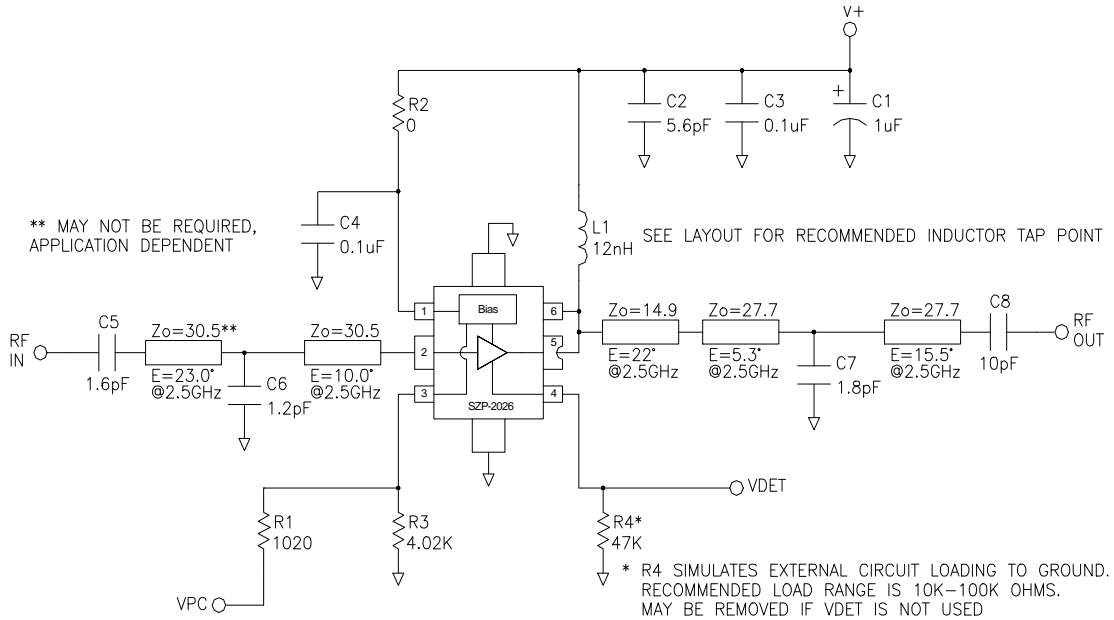


DESG	DESCRIPTION	NOTES
Q1	SZP-2026	50F-26
R1	1.02K OHM, 0603 1%	0402 may be used
R2	0 OHM, 0603	"
R3	4.02K OHM, 0603 1%	"
R4	47K OHM, 0603	"
C1	1uF 16V MLCC CAP	Tantalum ok for EVM performance. Use MLCC type for best IM3 levels.
C2	5.6pF CAP, 0603	NPO ROHM MCH185A5R6DK or equiv.
C3,4	0.1uF CAP, 0603	NPO, 0402 ok ROHM MCH184CN105K or equiv.
C5	2.0pF CAP, 0603	NPO, low ESR ATC 600S100JW250 or equiv.
C6	1.8pF CAP, 0603	NPO, low ESR ATC 600S2R0CW250 or equiv.
C7	2.0pF CAP, 0603	NPO, low ESR ATC 600S2R0CW250 or equiv.
C8	10pF CAP, 0603	NPO, low ESR ATC 600S100JW250 or equiv.
L1	12nH IND, 0805	Coilcraft 0805HQ-12NXJBB



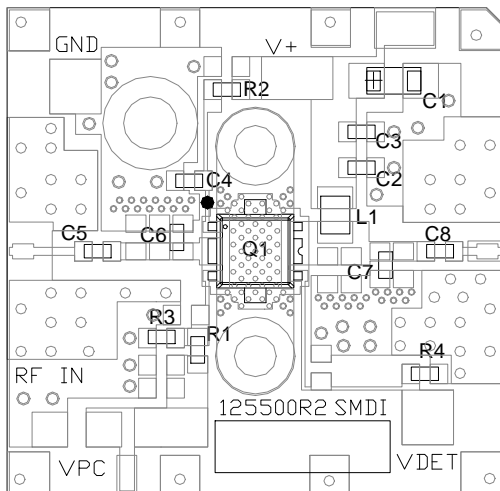
**Preliminary**  
**SZP-2026Z 2.2-2.7GHz 2W Power Amp**

**2.5-2.7 GHz Application Circuit For  $V_+ = V_{cc} = V_{pc} = 5.0V$**



**2.5-2.7GHz Evaluation Board Layout For  $V_+ = V_{cc} = V_{pc} = 5.0V$**

Board material GETEK, 10mil thick, Dk=3.9, 2 oz. copper



DESG	DESCRIPTION	NOTES
Q1	SZP-2026	S0F-26
R1	1.02K OHM, 0603 1%	0402 may be used
R2	0 OHM, 0603	"
R3	4.02K OHM, 0603 1%	"
R4	47K OHM, 0603	"
C1	1uF 16V MLCC CAP	Tantalum ok for EVM performance. Use MLCC type for best IM3 levels.
C2	5.6pF CAP, 0603	NPO ROHM MCH185A5R6DK or equiv.
C3,4	0.1uF CAP, 0603	NPO, 0402 ok ROHM MCH184CN105K or equiv.
C5	1.6pF CAP, 0603	NPO, low ESR ATC 600S100JW250 or equiv.
C6	1.2pF CAP, 0603	NPO, low ESR ATC 600S2R0CW250 or equiv.
C7	1.8pF CAP, 0603	NPO, low ESR ATC 600S2R0CW250 or equiv.
C8	10pF CAP, 0603	NPO, low ESR ATC 600S100JW250 or equiv.
L1	12nH IND, 0805	Coilcraft 0805HQ-12NXJBB



**Preliminary**  
**SZP-2026Z 2.2-2.7GHz 2W Power Amp**

**Part Symbolization**

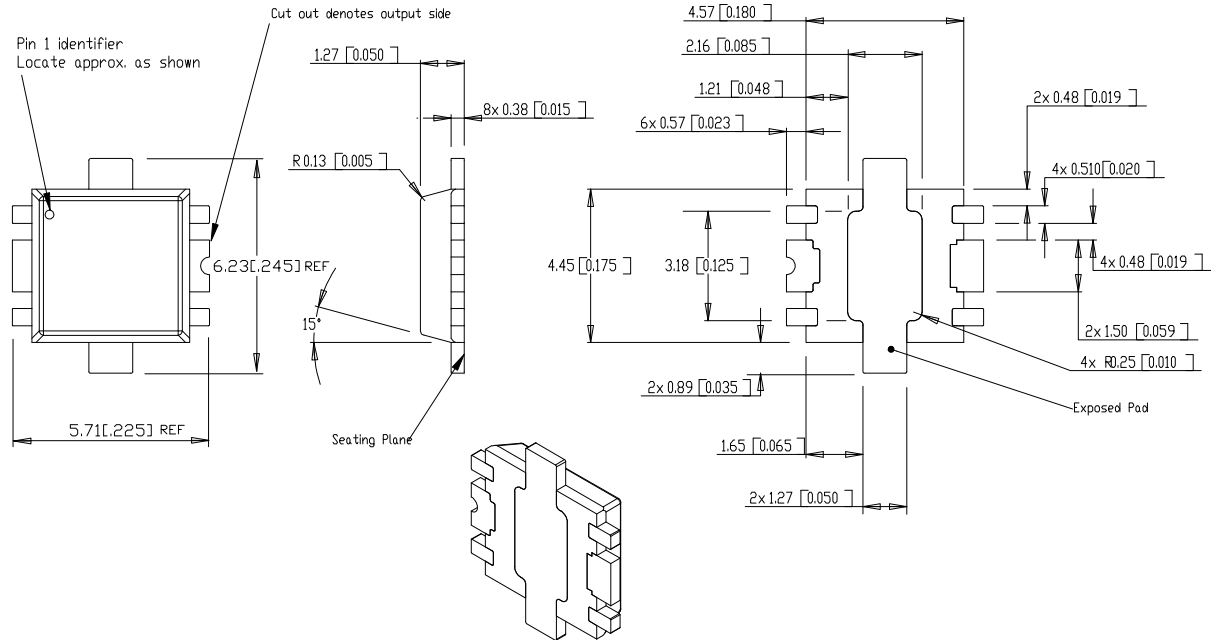
The part will be symbolized with "SZP-2026Z" to designate it as a RoHS green compliant product. Marking designator will be on the top surface of the package.

**Part Number Ordering Information**

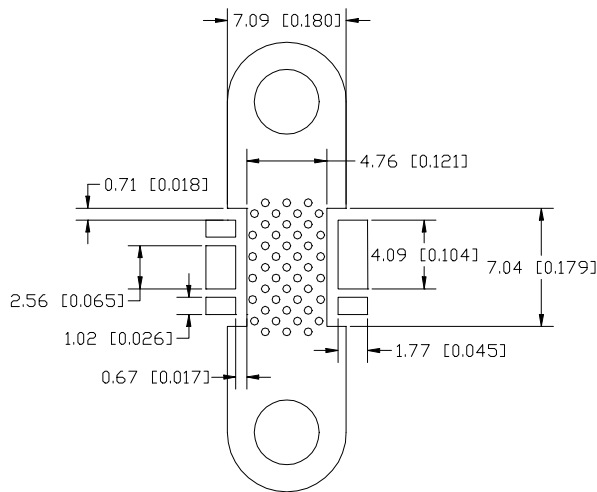
Part Number	Reel Size	Devices/Reel
SZP-2026Z*	13"	3000

\* Matte tin finish

**Package Outline Drawing (dimensions in mm [in]):**



**Recommended Metal Land Pattern (dimensions in mm [in]):**



303 South Technology Court Broomfield, CO 80021

Phone: (800) SMI-MMIC  
12

<http://www.sirenza.com>  
EDS-104611 Rev C

SUNSTAR 商斯达实业集团是集研发、生产、工程、销售、代理经销、技术咨询、信息服务等为一体的高科技企业，是专业高科技电子产品生产厂家，是具有 10 多年历史的专业电子元器件供应商，是中国最早和最大的仓储式连锁规模经营大型综合电子零部件代理分销商之一，是一家专业代理和分销世界各大品牌 IC 芯片和电子元器件的连锁经营综合性国际公司，专业经营进口、国产名厂名牌电子元件，型号、种类齐全。在香港、北京、深圳、上海、西安、成都等全国主要电子市场设有直属分公司和产品展示展销窗口门市部专卖店及代理分销商，已在全国范围内建成强大统一的供货和代理分销网络。我们专业代理经销、开发生产电子元器件、集成电路、传感器、微波光电元器件、工控机/DOC/DOM 电子盘、专用电路、单片机开发、MCU/DSP/ARM/FPGA 软件硬件、二极管、三极管、模块等，是您可靠的一站式现货配套供应商、方案提供商、部件功能模块开发配套商。商斯达实业公司拥有庞大的资料库，有数位毕业于著名高校——有中国电子工业摇篮之称的西安电子科技大学（西军电）并长期从事国防尖端科技研究的高级工程师为您精挑细选、量身订做各种高科技电子元器件，并解决各种技术问题。

微波光电部专业代理经销高频、微波、光纤、光电元器件、组件、部件、模块、整机；电磁兼容元器件、材料、设备；微波 CAD、EDA 软件、开发测试仿真工具；微波、光纤仪器仪表。欢迎国外高科技微波、光纤厂商将优秀产品介绍到中国、共同开拓市场。长期大量现货专业批发高频、微波、卫星、光纤、电视、CATV 器件：晶振、VCO、连接器、PIN 开关、变容二极管、开关二极管、低噪晶体管、功率电阻及电容、放大器、功率管、MMIC、混频器、耦合器、功分器、振荡器、合成器、衰减器、滤波器、隔离器、环行器、移相器、调制解调器；光电子器件和组件：红外发射管、红外接收管、光电开关、光敏管、发光二极管和发光二极管组件、半导体激光二极管和激光器组件、光电探测器和光接收组件、光发射接收模块、光纤激光器和光放大器、光调制器、光开关、DWDM 用光发射和接收器件、用户接入系统光收发器件与模块、光纤连接器、光纤跳线/尾纤、光衰减器、光纤适配器、光隔离器、光耦合器、光环行器、光复用器/转换器；无线收发芯片和模组、蓝牙芯片和模组。

更多产品请看本公司产品专用销售网站：

商斯达中国传感器科技信息网：<http://www.sensor-ic.com/>

商斯达工控安防网：<http://www.pc-ps.net/>

商斯达电子元器件网：<http://www.sunstare.com/>

商斯达微波光电产品网：[HTTP://www.rfoe.net/](http://www.rfoe.net/)

商斯达消费电子产品网：<http://www.icasic.com/>

商斯达实业科技产品网：<http://www.sunstars.cn/> 微波元器件销售热线：

地址：深圳市福田区福华路福庆街鸿图大厦 1602 室

电话：0755-82884100 83397033 83396822 83398585

传真：0755-83376182 (0) 13823648918 MSN: SUNS8888@hotmail.com

邮编：518033 E-mail:szss20@163.com QQ: 195847376

深圳赛格展销部：深圳华强北路赛格电子市场 2583 号 电话：0755-83665529 25059422

技术支持：0755-83394033 13501568376

欢迎索取免费详细资料、设计指南和光盘；产品凡多，未能尽录，欢迎来电查询。

北京分公司：北京海淀区知春路 132 号中发电子大厦 3097 号

TEL: 010-81159046 82615020 13501189838 FAX: 010-62543996

上海分公司：上海市北京东路 668 号上海赛格电子市场 D125 号

TEL: 021-28311762 56703037 13701955389 FAX: 021-56703037

西安分公司：西安高新开发区 20 所(中国电子科技集团导航技术研究所)

西安劳动南路 88 号电子商城二楼 D23 号

TEL: 029-81022619 13072977981 FAX:029-88789382